

L Number	Hits	Search Text	DB	Time stamp
7	1474	257/532.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/18 14:08
9	150	257/535.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/18 14:08
10	331	257/621.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/18 14:08
12	112	336/68.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/18 14:08
14	29	336/230.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/18 14:08
15	865	336/223.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/18 14:09
17	138	336/187.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/18 14:09
19	28217	inductor with capacitor	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/18 14:10
20	4109	(inductor with capacitor) and substrate	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/18 14:11
22	2054	((inductor with capacitor) and substrate) and dielectric	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/18 14:11
23	376	((((inductor with capacitor) and substrate) and dielectric) and (substrate near5 (via or hole or trench or groove)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/18 14:29
24	162	(((((inductor with capacitor) and substrate) and dielectric) and (substrate near5 (via or hole or trench or groove)))) and (spiral or circular)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/18 14:30
6	433	257/531.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/18 14:46
8	237	257/534.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/18 14:58

25	281	257/528.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/06/18 15:02
26	1606	257/774.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/06/18 15:04
27	605	257/728.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/06/18 15:08
28	1391	257/724.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/06/18 15:09
11	890	336/65.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/06/18 15:20
13	352	336/225.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/06/18 15:21
16	167	336/186.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/06/18 15:22
29	70	438/957.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/06/18 15:25
30	105	438/329.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/06/18 15:25
-	624	336/65.ccls.	USPAT	2002/12/02 12:23
-	101	336/68.ccls.	USPAT	2002/12/02 12:23
-	248	336/225.ccls.	USPAT	2002/12/02 12:23
-	27	336/230.ccls.	USPAT	2002/12/02 12:23
-	784	336/223.ccls.	USPAT	2002/12/02 12:23
-	135	336/186.ccls.	USPAT	2002/12/02 12:23
-	124	336/187.ccls.	USPAT	2002/12/02 12:23
-	1873	336/65.ccls. or 336/68.ccls. or 336/225.ccls. or 336/230.ccls. or 336/223.ccls. or 336/186.ccls. or 336/187.ccls.	USPAT	2002/12/02 12:24
-	221	(336/65.ccls. or 336/68.ccls. or 336/225.ccls. or 336/230.ccls. or 336/223.ccls. or 336/186.ccls. or 336/187.ccls.) and inductor	USPAT	2002/12/02 12:24

L Number	Hits	Search Text	DB	Time stamp
32	151	(RF or (radio adj frequency)) and substrate and (dielectric near3 layer) and ((metal or conduct\$4) near3 (layer or film)) with (spiral or circular))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/06/18 15:46
-	1	("6322634").PN.	USPAT	2002/06/12 11:03
-	11106	RF and substrate and dielectric	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/06/04 10:56
-	14	(RF and substrate and dielectric ) and (bias near4 feeding)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/06/04 10:55
-	4002	(RF or (radio adj frequency)) and substrate and (dielectric near3 layer) and ((metal or conduct\$4) near3 (layer or film))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/06/10 17:39
-	3346	((RF or (radio adj frequency)) and substrate and (dielectric near3 layer) and ((metal or conduct\$4) near3 (layer or film)) ) and (spiral or circ\$5)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/06/04 11:03
-	1	"5541442".PN.	USPAT	2002/06/04 14:39
-	1	"5446311".PN.	USPAT	2002/06/04 14:41
-	1	"5095357".PN.	USPAT	2002/06/04 14:42
-	1	"5384274".PN.	USPAT	2002/06/04 17:23
-	1	"5268315".PN.	USPAT	2002/06/04 17:23
-	1	"5174012".PN.	USPAT	2002/06/04 17:23
-	1	"5753949".PN.	USPAT	2002/06/05 11:02
-	1	"5583359".PN.	USPAT	2002/06/05 11:02
-	307	(RF or (radio adj frequency)) and substrate and (dielectric) and ((metal or conduct\$4) same ((via or feedthrough) and inductor))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/06/10 17:43
-	473	257/531	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/06/11 13:50
-	1667	257/532	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/06/11 13:01
-	221	257/534	USPAT	2002/06/12 11:04
-	206	257/535	USPAT	2002/06/12 11:04
-	265	257/621	USPAT	2002/06/12 11:04

IS&R 1 ("6322634").PN.  
BRS 11106 RF and substrate and dielectric  
BRS 14 (RF and substrate and dielectric ) and (bias near4 feeding)  
BRS 4002 (RF or (radio adj frequency)) and substrate and (dielectric near3 layer) and  
((metal or conduct\$4) near3 (layer or film))  
BRS 3346 ((RF or (radio adj frequency)) and substrate and (dielectric near3 layer)  
and ((metal or conduct\$4) near3 (layer or film)) ) and (spiral or circ\$5)  
BRS 1009 ((RF or (radio adj frequency)) and substrate and (dielectric near3 layer)  
and ((metal or conduct\$4) near3 (layer or film)) ) and (spiral or circular)  
BRS 1 "5541442".PN.  
BRS 1 "5446311".PN.  
BRS 1 "5095357".PN.  
BRS 1 "5384274".PN.  
BRS 1 "5268315".PN.  
BRS 1 "5174012".PN.  
BRS 1 "5753949".PN.  
BRS 1 "5583359".PN.  
BRS 307 (RF or (radio adj frequency)) and substrate and (dielectric) and ((metal or  
conduct\$4) same ((via or feedthrough) and inductor))  
BRS 473 257/531  
BRS 1667 257/532  
BRS 221 257/534  
BRS 206 257/535  
BRS 265 257/621